ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan	PC. Bannock	burn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities and the declaration entities are an entities and the declaration entities are an entities are an entities are an entities and the declaration entities are an entits are an entities are an entits are an entities are an entities	on of the su	bstances v all lower	vithin the manufactu level materials for v	rer listed which the r	item. Note: nanufacture	if the item is an as er has engineering	sembly with low responsibility.	
IPC Web Site for Information on IPC-1752 Standard Form Ty				Form Type Distribute	*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg					Ifg Informa	tion		
Supplier Information														
Company name* Company			pany unique ID			Unique ID Authority				Respon	Response Date*			
nsemi										2024-05	2024-05-21			
Contact Name	act Name Title - Contact					Phone - Contact*				Email -	Email - Contact*			
roduct-Env-Stewards Product Enviro Compli			ro Compliance	Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			sentative	Itative I		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	М	lanufacturing Site		Weight*	UOM	Unit Type	
	MC74L G	IC74LVX244DWR2 LOG CMOS BUFR		FR 3ST OCTL		2024-05-21	PH1		H1		517.71	mg	Each	
Aanufacturing Proccess Informat	tion													
Terminal Plating / Grid Array Ma	terial	l Terminal Base Alloy J		J-STD-020 MSI	Rating	Peak Proce	cess Body Temperature Max Time at Peak		c Tempera	ture Num	ber of Reflow Cyc	les		
Matte Tin (Sn) - annealed CU Alloy			3		260	260 C		30		nds 3				
omments														
TTENTION: MSL 3 Rated item requires	s Bake and I	Dry Pack (after	electrical test)											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).										
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure		
Die	9.33	mg	Supplier	Silicon (Si)	7440-21-3		9.33	mg		
Die Attach	20.68	mg	Supplier	Silver (Ag)	7440-22-4		15.51	mg		
			Supplier	Epoxy resins	129915-35-1		5.17	mg		
Lead Frame	323.98	mg	Supplier	Silver (Ag)	7440-22-4		3.2398	mg		
			Supplier	Zinc (Zn)	7440-66-6		0.648	mg		
			Supplier	Iron (Fe)	7439-89-6		8.4235	mg		
			Supplier	Copper (Cu)	7440-50-8		311.6688	mg		
Mold Compound-Black	158.46	mg		Epoxy Phenol Resin	proprietary data		16.6383	mg		
			Supplier	Fused Silica (SiO2)	60676-86-0		141.8217	mg		
Plating	4.79	mg	Supplier	Tin (Sn)	7440-31-5		4.79	mg		
Wire Bond - Au	0.47	mg	Supplier	Gold (Au)	7440-57-5		0.47	mg		

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted)